

Released Engineering Change Notice

Product	GL2800/3800
Title	Various pcb`s to be up-issued to prevent solder shorts.
Date	16/01/07

Details Of Change
<p>Panels AG5863, AG5864, AG5865, AG5866 and AG5867 to be up-issued.</p> <p>AG5863 up-issued to issue 2, AG5864 up-issued to issue 5, AG5865 up-issued to issue 5, AG5866 up-issued to issue 4,AG5867 up-issued to issue 3. Tented vias (top-side only) included in these up-issues to overcome the solder shorting.</p>

Reason for change
<p>Ref Vtech notification that these panels are prone to solder shorts in manufacture using flow-solder (mainly due to through-hole vias being too close).</p>

This ECN supersedes ECN No.	Vtech187
	Related ECNs

Post Implementation Ser No	
Serial Number	Model
	GL2800
	Feb 07

Serial Number	Model	Date

Additional Information

Assy no.	Pcb no.	SMT/AI/RI Program and Barcode Issue updates (from _ to _)		
003-353	AG5863		to	Issue 2
003-438	AG5863		to	Issue 2
003-355	AG5865		to	Issue 5
003-440	AG5865		to	Issue 5
003-354	AG5864		to	Issue 5
003-439	AG5864		to	Issue 5
003-367	AG5867		to	Issue 3
003-443	AG5867		to	Issue 3
003-369	AG5866		to	Issue 4
003-442	AG5866		to	Issue 4